

New Product

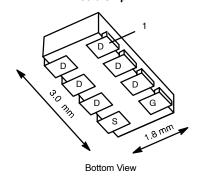
P-Channel 20-V (D-S) MOSFET

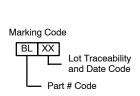
PRODUCT SUMMARY					
V _{DS} (V)	$r_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ)		
	0.037 @ V _{GS} = -4.5 V	-6.7			
-20	0.050 @ V _{GS} = -2.5 V	-5.9	15		
	0.070 @ V _{GS} = -1.8 V	-5.0			

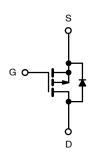
FEATURES

TrenchFET® Power MOSFET

1206-8 ChipFET®







P-Channel MOSFET

Ordering Information: Si5433BDC-T1—E3

Parameter		Symbol	5 secs	Steady State	Unit	
Drain-Source Voltage		V _{DS}	-20		V	
Gate-Source Voltage		V _{GS}	±8			
Continuous Dusis Comment /T 1500C\8	T _A = 25°C	. I _D	-6.7	-4.8	Α	
Continuous Drain Current (T _J = 150°C) ^a	T _A = 85°C		-4.8	-3.5		
Pulsed Drain Current		I _{DM}	-20		A	
Continuous Source Currenta		I _S	-2.1	-1.1		
Maximum Power Dissipation ^a	T _A = 25°C	Б	2.5	1.3	14/	
	T _A = 85°C	P _D	1.3	0.7	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150		°C	
Soldering Recommendations (Peak Temperature)b, c			260		C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
	t ≤ 5 sec	_	45	50		
Maximum Junction-to-Ambient ^a	Steady State	R _{thJA}	85	95	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	17	20		

- Surface Mounted on 1" x 1" FR4 Board.

 See Reliability Manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder
- Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

Vishay Siliconix

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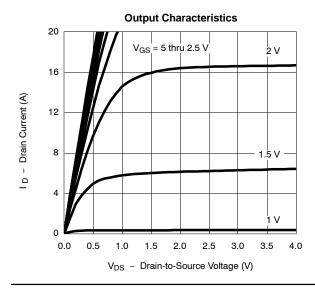


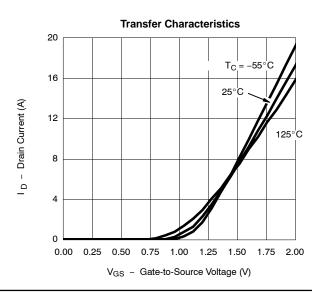
SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)							
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-0.45		-1.0	V	
Gate-Body Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ±8 V			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$			-1 -5	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \leq -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	-20			Α	
		$V_{GS} = -4.5 \text{ V}, I_D = -4.8 \text{ A}$		0.030	0.037		
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = -2.5 \text{ V}, I_D = -4.2 \text{ A}$		0.041	0.050	Ω	
		$V_{GS} = -1.8 \text{ V}, I_D = -1 \text{ A}$		0.056	0.070		
Forward Transconductancea	9fs	V _{DS} = -10 V, I _D = -4.8 A		18		S	
Diode Forward Voltage ^a	V _{SD}	I _S = -1.1 A, V _{GS} = 0 V		-0.8	-1.2	V	
Dynamic ^b							
Total Gate Charge	Qg			15	22	nC	
Gate-Source Charge	Q _{gs}	V_{DS} = -10 V, V_{GS} = -4.5 V, I_D = -4.8 A		2.4			
Gate-Drain Charge	Q _{gd}			3.6			
Gate Resistance	R_{g}			10		Ω	
Turn-On Delay Time	t _{d(on)}			12	25		
Rise Time	t _r	$V_{DD} = -10 \text{ V. R}_1 = 10 \Omega$		25	40	1	
Turn-Off Delay Time	t _{d(off)}	V_{DD} = -10 V, R_L = 10 Ω $I_D \cong -1$ A, V_{GEN} = -4.5 V, R_g = 6 Ω		80	120	ns	
Fall Time	t _f			55	85		
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = -1.1 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$		30	60	1	

- $\begin{array}{ll} \mbox{Notes} \\ \mbox{a.} & \mbox{Pulse test; pulse width} \leq 300~\mu\mbox{s, duty cycle} \leq 2\%. \\ \mbox{b.} & \mbox{Guaranteed by design, not subject to production testing.} \end{array}$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)







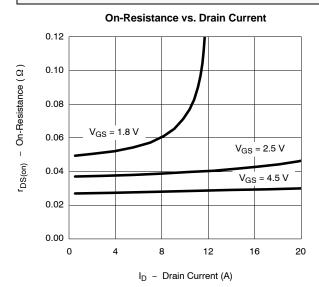
V_{GS} - Gate-to-Source Voltage (V)

Source Current (A)

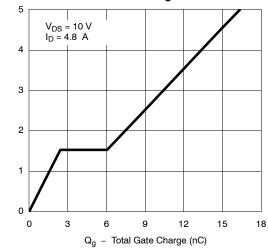
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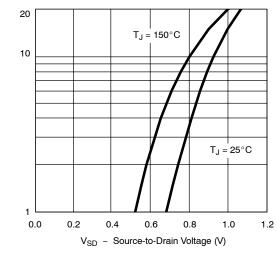
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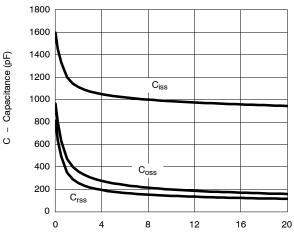




Source-Drain Diode Forward Voltage

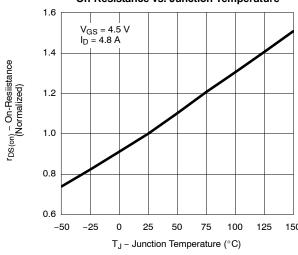


Capacitance

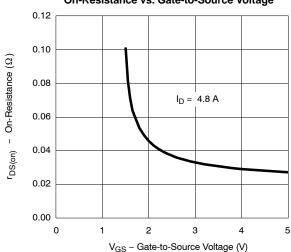


V_{DS} - Drain-to-Source Voltage (V)

On-Resistance vs. Junction Temperature



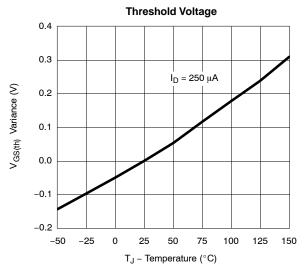
On-Resistance vs. Gate-to-Source Voltage

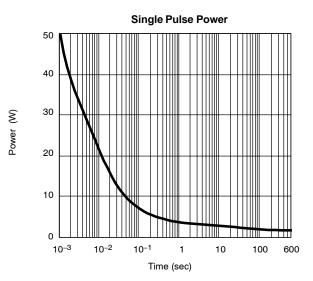


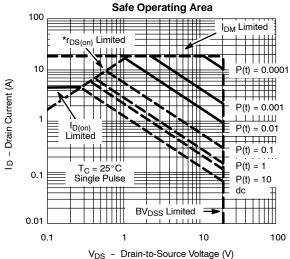
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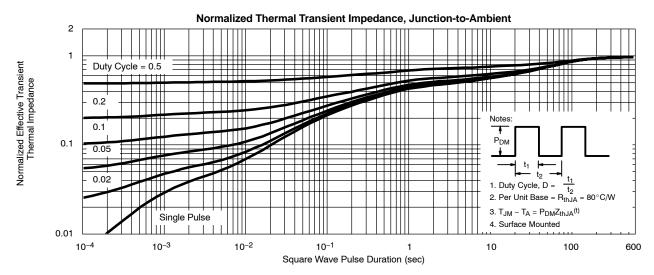
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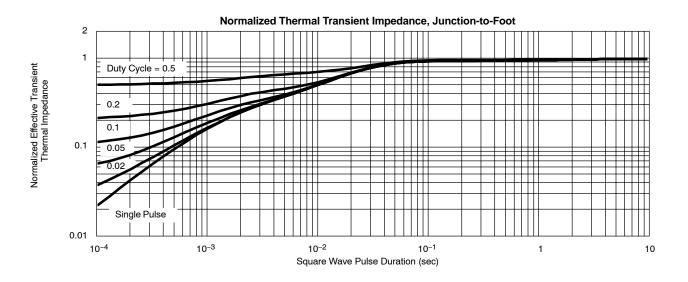


 $\begin{array}{lll} V_{DS} & - & Drain-to-Source \ Voltage \ (V) \\ ^*V_{GS} & > & minimum \ V_{GS} \ at \ which \ r_{DS(on)} \ is \ specified \end{array}$





TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?73208.

Legal Disclaimer Notice



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